INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Feb 03 IC24 Data Handbook 1998 Apr 20



Semiconductors

Philips

74LV04

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Output capability: standard
- I_{CC} category: SSI

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5$ ns

DESCRIPTION

The 74LV04 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC/HCT04.

The 74LV04 provides six inverting buffers.

| SYMBOL | PARAMETER | TYPICAL | UNIT | |
|------------------------------------|--|--|------|----|
| t _{PHL} /t _{PLH} | Propagation delay nA to nY | C _L = 15 pF; V _{CC} = 3.3 V | 6 | ns |
| Cl | Input capacitance | | 3.5 | pF |
| C _{PD} | Power dissipation capacitance per gate | See Notes NO TAG and 2 | 21 | pF |

NOTES:

- C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) 1. P_D = C_{PD} × V_{CC}² × f_i + \sum (C_L × V_{CC}² × f_o) where: f_i = input frequency in MHz; C_L = output load capacitance in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V; \sum (C_L × V_{CC}² × f_o) = sum of the outputs. 2. The condition is V₁ is V₁ = GND to V_{CC}.

ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | PKG. DWG. # |
|-----------------------------|-------------------|-----------------------|---------------|-------------|
| 14-Pin Plastic DIL | –40°C to +125°C | 74LV04 N | 74LV04 N | SOT27-1 |
| 14-Pin Plastic SO | –40°C to +125°C | 74LV04 D | 74LV04 D | SOT108-1 |
| 14-Pin Plastic SSOP Type II | –40°C to +125°C | 74LV04 DB | 74LV04 DB | SOT337-1 |
| 14-Pin Plastic TSSOP Type I | –40°C to +125°C | 74LV04 PW | 74LV04PW DH | SOT402-1 |

PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION | | |
|--------------------|-----------------|-------------------------|--|--|
| 1, 3, 5, 9, 11, 13 | 1A – 6A | Data inputs | | |
| 2, 4, 6, 8, 10, 12 | 1Y – 6Y | Data outputs | | |
| 7 | GND | Ground (0 V) | | |
| 14 | V _{CC} | Positive supply voltage | | |

FUNCTION TABLE

| INPUTS | OUTPUTS |
|--------|---------|
| nA | nY |
| L | Н |
| н | L |

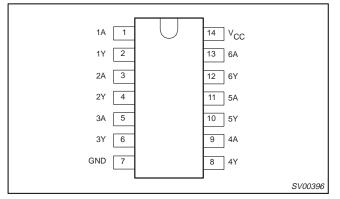
NOTES:

H = HIGH voltage level

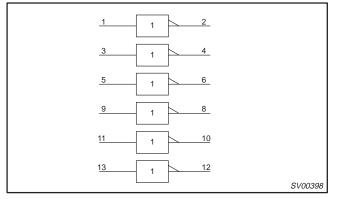
L = LOW voltage level

74LV04

PIN CONFIGURATION



LOGIC SYMBOL (IEEE/IEC)

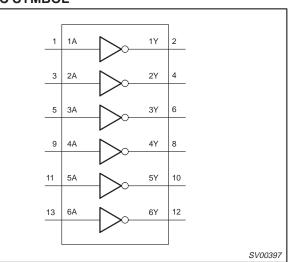


RECOMMENDED OPERATING CONDITIONS

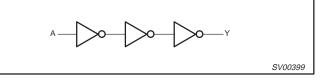
SYMBOL PARAMETER CONDITIONS MIN MAX UNIT TYP See Note^{NO TAG} 5.5 DC supply voltage 1.0 3.3 V V_{CC} 0 V VI Input voltage _ Vcc Output voltage 0 V Vo V_{CC} _ See DC and AC -40 +85 °C Operating ambient temperature range in free air Tamb characteristics -40 +125 500 _ _ _ 200 _ Input rise and fall times ns/V $t_{\rm r},\,t_{\rm f}$ 100 _ _ _ 50

NOTE:

1. The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.



LOGIC DIAGRAM (ONE INVERTER)



74LV04

ABSOLUTE MAXIMUM RATINGSNO TAG, NO TAG

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|------------------------------|---|--|-------------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +7.0 | V |
| $\pm I_{IK}$ | DC input diode current | $V_{\rm I} < -0.5 \text{ or } V_{\rm I} > V_{\rm CC} + 0.5 V$ | 20 | mA |
| ± I _{OK} | DC output diode current | $V_{\rm O}$ < -0.5 or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5V | 50 | mA |
| $\pm I_{O}$ | DC output source or sink current – standard outputs | $-0.5V < V_O < V_{CC} + 0.5V$ | 25 | mA |
| $^{\pmI_{GND},}_{\pmI_{CC}}$ | DC V _{CC} or GND current for types with – standard outputs | | 50 | mA |
| T _{stg} | Storage temperature range | | -65 to +150 | °C |
| P _{TOT} | Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP) | for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K | 750 500 400 | mW |

NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

| | | | | | LIMITS | | | | |
|----------------------------------|---|--|-----------------------|----------------|-----------------------|-----------------------|-----------------------|-----|--|
| SYMBOL | PARAMETER | TEST CONDITIONS | -40 | °C to +8 | 5°C | -40°C to | o +125°C | | |
| 01 | | | MIN | TYP. NO TAG | МАХ | MIN | МАХ | | |
| | | V _{CC} = 1.2V | 0.9 | | | 0.9 | | | |
| Maria | HIGH level Input | $V_{CC} = 2.0V$ | 1.4 | | | 1.4 | | V | |
| VIH | voltage | V _{CC} = 2.7 to 3.6V | 2.0 | | | 2.0 | | 1 ` | |
| | | V _{CC} = 4.5 to 5.5V | 0.7 * V _{CC} | | | 0.7 * V _{CC} | | 1 | |
| | | $V_{CC} = 1.2V$ | | | 0.3 | | 0.3 | | |
| VIL | LOW level Input | $V_{CC} = 2.0V$ | | | 0.6 | | 0.6 | | |
| ۷L | voltage | V _{CC} = 2.7 to 3.6V | | | 0.8 | | 0.8 | 1 Č | |
| | | V _{CC} = 4.5 to 5.5 | | | 0.3 * V _{CC} | | 0.3 * V _{CC} | | |
| | | $V_{CC} = 1.2V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$ | | 1.2 | | | | | |
| | | $V_{CC} = 2.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$ | 1.8 | 2.0 | | 1.8 | |] | |
| V _{OH} | HIGH level output voltage; all outputs | $V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$ | 2.5 | 2.7 | | 2.5 | | V | |
| | | $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$ | 2.8 | 3.0 | | 2.8 | |] | |
| | | V_{CC} = 4.5V; V_I = V_{IH} or $V_{IL;}$ – I_O = 100 μ A | 4.3 | 4.5 | | 4.3 | | | |
| V _{ОН} | HIGH level output voltage; | $V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 6mA$ | 2.40 | 2.82 | | 2.20 | | v | |
| VОН | STANDARD outputs | V_{CC} = 4.5V; V_{I} = V_{IH} or $V_{IL;}$ – I_{O} = 12mA | 3.60 | 4.20 | | 3.50 | | ľ | |
| | | V_{CC} = 1.2V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A | | 0 | | | | | |
| | | V_{CC} = 2.0V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A | | 0 | 0.2 | | 0.2 | | |
| V _{OL} LOW level output | voltage; all output | V_{CC} = 2.7V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A | | 0 | 0.2 | | 0.2 | V | |
| | | V_{CC} = 3.0V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A | | 0 | 0.2 | | 0.2 | | |
| | | V_{CC} = 4.5V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A | | 0 | 0.2 | | 0.2 | | |
| Vol | LOW level output voltage; $V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 6mA$ | | | 0.25 | 0.40 | | 0.50 | v | |
| * OL | STANDARD outputs | V_{CC} = 4.5V; V_{I} = V_{IH} or $V_{IL;}$ I_{O} = 12mA | | 0.35 | 0.55 | | 0.65 | | |

74LV04

DC ELECTRICAL CHARACTERISTICS (Continued)

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

| | | | LIMITS | | | | | | |
|------------------|---|---|----------------|----------------|------|----------|--------|------|--|
| SYMBOL | PARAMETER TEST CONDITIONS | | -40°C to +85°C | | | -40°C to | +125°C | UNIT | |
| | | | MIN | TYP. NO TAG | МАХ | MIN | MAX | | |
| I | Input leakage current | V_{CC} = 5.5V; V_{I} = V_{CC} or GND | | | 1.0 | | 1.0 | μA | |
| I _{CC} | Quiescent supply current; SSI | V_{CC} = 5.5V; V_{I} = V_{CC} or GND; I_{O} = 0 | | | 20.0 | | 40 | μA | |
| ΔI _{CC} | Additional quiescent supply current | $V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$ | | | 500 | | 850 | μΑ | |

NOTE:

1. All typical values are measured at $T_{amb} = 25^{\circ}C$.

AC CHARACTERISTICS

GND = 0V; $t_r = t_f \le 2.5$ ns; $C_L = 50$ pF; $R_L = 1$ K Ω

| | | | CONDITION | | | LIMITS | | | |
|------------------------------------|------------------------------------|----------|---------------------|------------|---------------|---------------------|---------------|-----|------|
| SYMBOL | PARAMETER | WAVEFORM | CONDITION | - | 40 to +85° | С | –40 to +125°C | | UNIT |
| | | | V _{CC} (V) | MIN | TYP NO TAG | МАХ | MIN | МАХ | |
| | | | 1.2 | | 40 | | | | |
| | | | 2.0 | | 14 | 20 | | 25 | |
| t _{PHL} /t _{PLH} | Propagation delay nA to nY Figu | Figure 1 | 2.7 | | 10 | 15 | | 19 | ns |
| | | | | 3.0 to 3.6 | | 8 ^{NO TAG} | 12 | | 15 |
| | | | 4.5 to 5.5 | | | 9 | | 11 | |

NOTES:

1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^{\circ}C$ 2. Typical values are measured at $V_{CC} = 3.3 \text{ V}$.

AC WAVEFORMS

 V_M = 1.5 V at $V_{CC} \ge 2.7$ V and ≤ 3.6 V; V_M = 0.5 \times V_{CC} at V_{CC} < 2.7 V and \geq 4.5 V; $V_{\mbox{OL}}$ and $V_{\mbox{OH}}$ are the typical output voltage drop that occur with the output load.

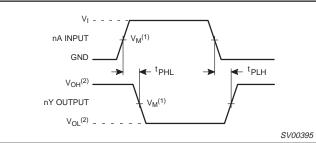


Figure 1. Input (nA) to output (nY) propagation delays and output transition times.

TEST CIRCUIT

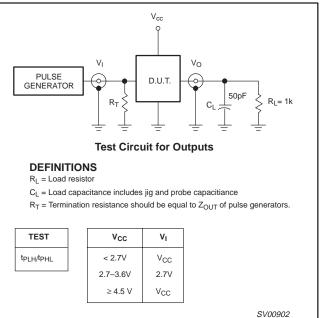


Figure 2. Load circuitry for switching times

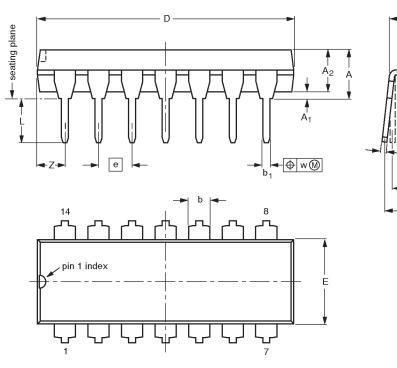
| | | | | | Ϋ́ | | | 7 | ¥ | | | | | | |
|----------|-----------|------------------------|------------------------|----------------|----------------|----------------|------------------|------------------|----------|----------------|--------------|----------------|----------------|-------|--------------------------|
| DIMENSIC | DNS (inch | ndimensi | ions are o | derived f | rom the c | 0 L | 5 sca | le | 10 m | ım | | | | | |
| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | c | D ⁽¹⁾ | E ⁽¹⁾ | e | e ₁ | L | M _E | M _H | w | Z ⁽¹⁾ max. |
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.13 | 0.53 0.38 | 0.36 0.23 | 19.50 18.55 | 6.48 6.20 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 2.2 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.044 | 0.021 0.015 | 0.014 0.009 | 0.77 0.73 | 0.26 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.087 |

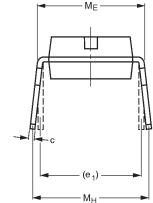
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | | | | |
|---------|--------|----------|----------|--|------------|----------------------------------|--|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | ISSUE DATE | |
| SOT27-1 | 050G04 | MO-001AA | | | | -92-11-17 95-03-11 | |

6





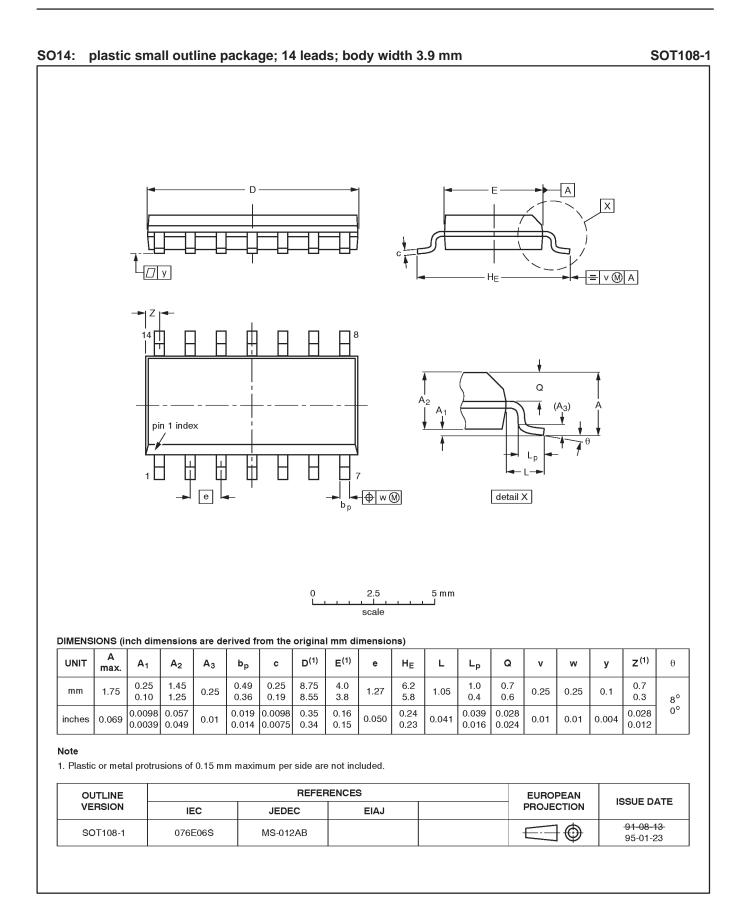
DIP14: plastic dual in-line package; 14 leads (300 mil)

74LV04

SOT27-1

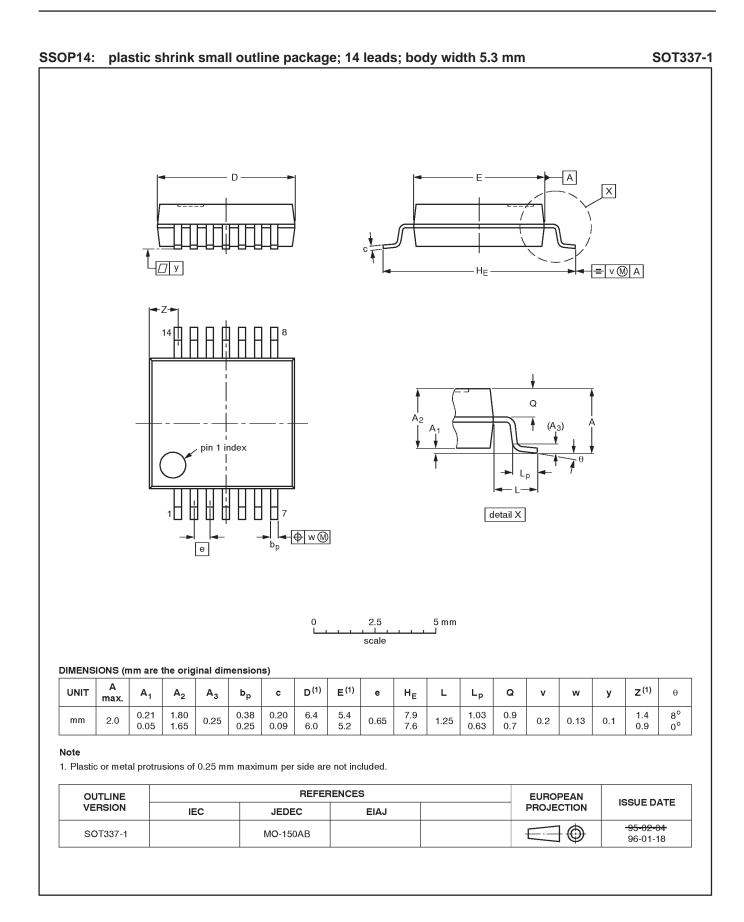
Product specification

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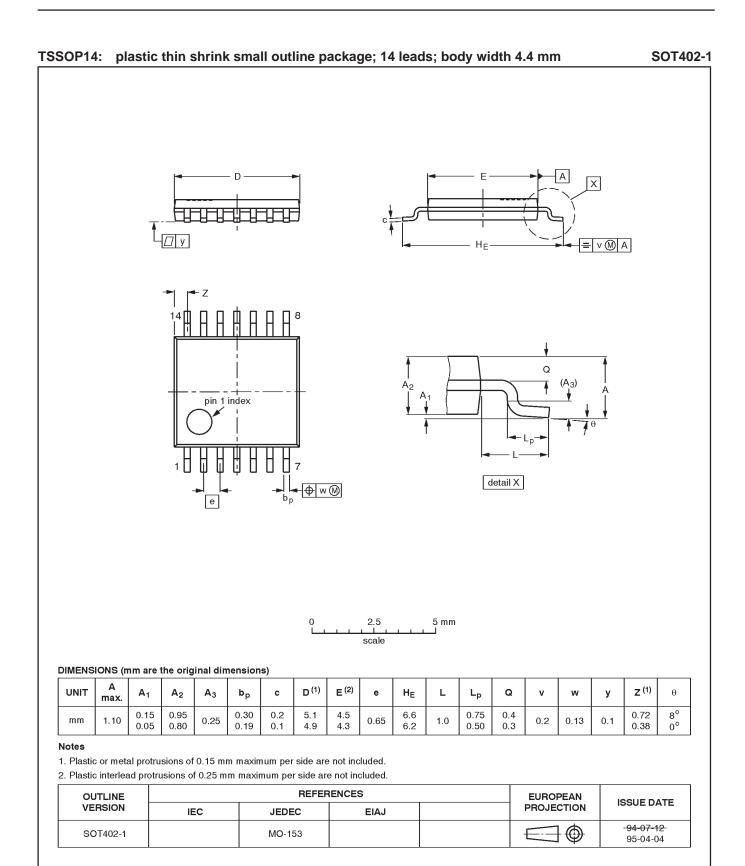


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| | DEFINITIONS | | | | | | | |
|---------------------------|------------------------|--|--|--|--|--|--|--|
| Data Sheet Identification | Product Status | Definition | | | | | | |
| Objective Specification | Formative or in Design | This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice. | | | | | | |
| Preliminary Specification | Preproduction Product | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. | | | | | | |
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Document order number:

Date of release: 05-96 9397-750-04404

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